

# SN74LS86

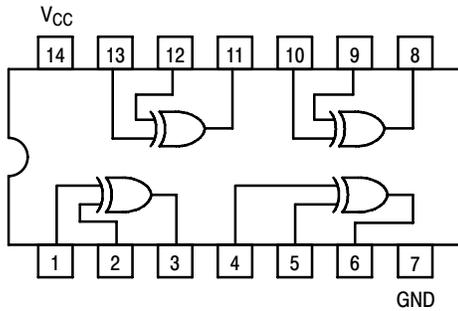
## Quad 2-Input Exclusive OR Gate



ON Semiconductor™

<http://onsemi.com>

LOW  
POWER  
SCHOTTKY

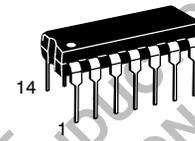


TRUTH TABLE

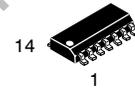
IN		OUT
A	B	Z
L	L	L
L	H	H
H	L	H
H	H	L

### GUARANTEED OPERATING RANGES

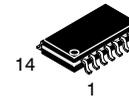
Symbol	Parameter	Min	Typ	Max	Unit
$V_{CC}$	Supply Voltage	4.75	5.0	5.25	V
$T_A$	Operating Ambient Temperature Range	0	25	70	°C
$I_{OH}$	Output Current - High			-0.4	mA
$I_{OL}$	Output Current - Low			8.0	mA



PLASTIC  
N SUFFIX  
CASE 646



SOIC  
D SUFFIX  
CASE 751A



SOEIAJ  
M SUFFIX  
CASE 965

### ORDERING INFORMATION

Device	Package	Shipping
SN74LS86N	14 Pin DIP	2000 Units/Box
SN74LS86D	SOIC-14	55 Units/Rail
SN74LS86DR2	SOIC-14	2500/Tape & Reel
SN74LS86M	SOEIAJ-14	See Note 1
SN74LS86MEL	SOEIAJ-14	See Note 1

1. For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

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## DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol	Parameter	Limits			Unit	Test Conditions
		Min	Typ	Max		
$V_{IH}$	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs
$V_{IL}$	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs
$V_{IK}$	Input Clamp Diode Voltage		-0.65	-1.5	V	$V_{CC} = \text{MIN}$ , $I_{IN} = -18 \text{ mA}$
$V_{OH}$	Output HIGH Voltage	2.7	3.5		V	$V_{CC} = \text{MIN}$ , $I_{OH} = \text{MAX}$ , $V_{IN} = V_{IH}$ or $V_{IL}$ per Truth Table
$V_{OL}$	Output LOW Voltage		0.25	0.4	V	$I_{OL} = 4.0 \text{ mA}$ $V_{CC} = V_{CC} \text{ MIN}$ , $V_{IN} = V_{IL}$ or $V_{IH}$ per Truth Table
			0.35	0.5	V	
$I_{IH}$	Input HIGH Current			40	$\mu\text{A}$	$V_{CC} = \text{MAX}$ , $V_{IN} = 2.7 \text{ V}$
				0.2	mA	$V_{CC} = \text{MAX}$ , $V_{IN} = 7.0 \text{ V}$
$I_{IL}$	Input LOW Current			-0.8	mA	$V_{CC} = \text{MAX}$ , $V_{IN} = 0.4 \text{ V}$
$I_{OS}$	Short Circuit Current (Note 2)	-20		-100	mA	$V_{CC} = \text{MAX}$
$I_{CC}$	Power Supply Current			10	mA	$V_{CC} = \text{MAX}$

2. Not more than one output should be shorted at a time, nor for more than 1 second.

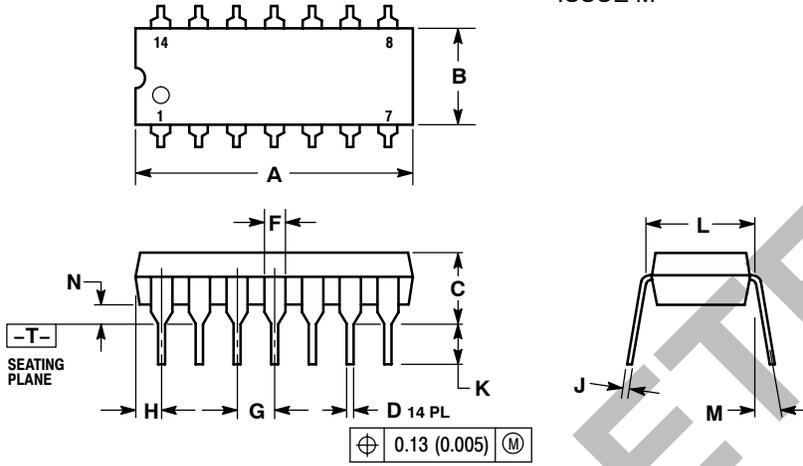
## AC CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )

Symbol	Parameter	Limits			Unit	Test Conditions
		Min	Typ	Max		
$t_{PLH}$ $t_{PHL}$	Propagation Delay, Other Input LOW		12 10	23 17	ns	$V_{CC} = 5.0 \text{ V}$ $C_L = 15 \text{ pF}$
$t_{PLH}$ $t_{PHL}$	Propagation Delay, Other Input HIGH		20 13	30 22	ns	

# SN74LS86

## PACKAGE DIMENSIONS

### N SUFFIX PLASTIC PACKAGE CASE 646-06 ISSUE M

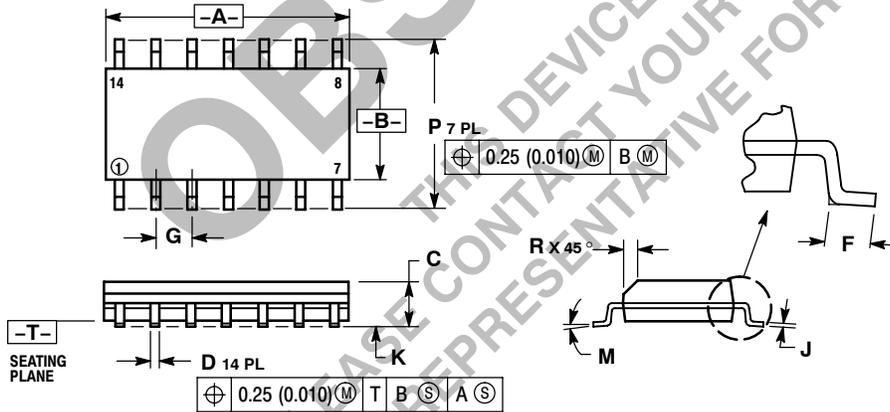


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	18.80
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC 2.54 BSC			
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
M	--- 10° --- 10°			
N	0.015	0.039	0.38	1.01

### D SUFFIX PLASTIC SOIC PACKAGE CASE 751A-03 ISSUE F



NOTES:

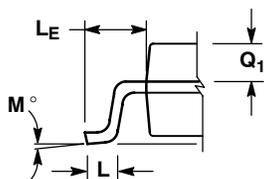
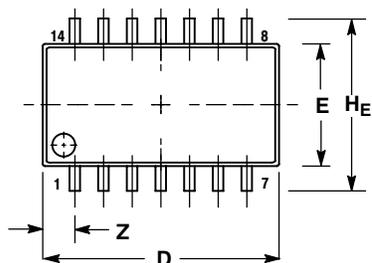
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0° 7° 0° 7°			
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

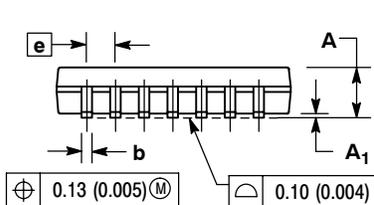
# SN74LS86

## PACKAGE DIMENSIONS

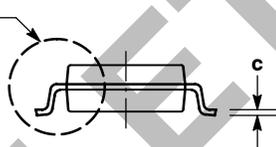
**M SUFFIX**  
**SOEIAJ PACKAGE**  
**CASE 965-01**  
**ISSUE O**



**DETAIL P**



**VIEW P**



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H <sub>E</sub>	7.40	8.20	0.291	0.323
0.50	0.50	0.85	0.020	0.033
L <sub>E</sub>	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Z	---	1.42	---	0.056

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